

Data Sheet October 1999 File Number 1560.3

# 2A, 60V, 0.950 Ohm, Logic Level, N-Channel Power MOSFET

The RFL2N06L N-channel enhancement mode silicon gate power field effect transistor is designed for applications such as switching regulators, switching converters, motor drivers, relay drivers and drivers for high power bipolar switching transistors requiring high speed and low gate drive power. These types can be operated directly from integrated circuits.

Formerly developmental type TA9520.

## **Ordering Information**

PART NUMBER	PACKAGE	BRAND		
RFL2N06L	TO-205AF	RFL2N06L		

NOTE: When ordering, use the entire part number.

#### **Features**

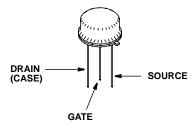
- 2A, 50V and 60V
- $r_{DS(ON)} = 0.950\Omega$
- Design Optimized for 5V Gate Drives
- · Can be Driven from QMOS, NMOS, TTL Circuits
- Compatible with Automotive Drive Requirements
- · SOA is Power Dissipation Limited
- · Nanosecond Switching Speeds
- · Linear Transfer Characteristics
- High Input Impedance
- · Majority Carrier Device

## Symbol



# **Packaging**

#### **JEDEC TO-205AF**



#### RFL2N06L

## **Absolute Maximum Ratings** $T_C = 25^{\circ}C$ , Unless Otherwise Specified

	RFL2N06L	UNITS
Drain to Source Voltage (Note 1)	50	V
Drain to Gate Voltage ( $R_{GS} = 20K\Omega$ ) (Note 1)	60	V
Continuous Drain Current	2	Α
Pulsed Drain Current (Note 3)	10	Α
Gate to Source Voltage	±10	V
Maximum Power Dissipation	8.33	W
Above T <sub>C</sub> = 25°C, Derate Linearly	0.0667	W/oC
Operating and Storage Temperature	-55 to 150	°C
Maximum Temperature for Soldering Leads at 0.063in (1.6mm) from Case for 10sT <sub>L</sub>	300	°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

#### NOTE:

1.  $T_J = 25^{\circ}C$  to  $125^{\circ}C$ .

# **Electrical Specifications** $T_C = 25^{\circ}C$ , Unless Otherwise Specified

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Drain to Source Breakdown Voltage	BV <sub>DSS</sub>	$I_D = 250 \mu A, V_{GS} = 0 V$	60	-	-	V
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}$ , $I_D = 250\mu A$ , (Figure 8)	1	-	2	V
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = Rated BV <sub>DSS</sub> , V <sub>GS</sub> = 0V	-	-	1	μА
		$V_{DS} = 0.8 \text{ x Rated BV}_{DSS}, V_{GS} = 0V, T_{C} = 125^{\circ}C$	-	-	25	μА
Gate to Source Leakage Current	I <sub>GSS</sub>	$V_{GS} = \pm 10V, V_{DS} = 0V$	-	-	±100	nA
Drain to Source On Voltage (Note 2)	V <sub>DS(ON)</sub>	I <sub>D</sub> = 2A, V <sub>GS</sub> = 5V	-	-	1.9	V
Drain to Source On Resistance (Note 2)	r <sub>DS(ON)</sub>	I <sub>D</sub> =2A, V <sub>GS</sub> = 5V, (Figures 6, 7)		-	0.950	Ω
Turn-On Delay Time	t <sub>d(ON)</sub>	$I_D$ = 2A, $V_{DD}$ = 30V, $R_G$ = 6.25 $\Omega$ , $R_L$ = 30 $\Omega$ $V_{GS}$ = 5V, (Figures 10, 11, 12)	-	10	20	ns
Rise Time	t <sub>r</sub>		-	65	130	ns
Turn-Off Delay Time	t <sub>d(OFF)</sub>		-	20	40	ns
Fall Time	t <sub>f</sub>		-	30	60	ns
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 25V, f = 1MHz, (Figure 9)	-	-	225	pF
Output Capacitance	C <sub>OSS</sub>		-	-	100	pF
Reverse Transfer Capacitance	C <sub>RSS</sub>			-	40	pF
Thermal Resistance Junction to Case	$R_{ heta JC}$		-	-	15	°C/W

## **Source to Drain Diode Specifications**

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Source to Drain Diode Voltage (Note 2)	V <sub>SD</sub>	I <sub>SD</sub> = 2A	-	-	1.4	V
Diode Reverse Recovery Time	t <sub>rr</sub>	$I_{SD} = 2A$ , $dI_{SD}/dt = 100A/\mu s$	-	150	-	ns

#### NOTES:

- 2. Pulse test: pulse width  $\leq 300 \mu s$ , duty cycle  $\leq 2\%$ .
- 3. Repetitive rating: pulse width limited by maximum junction temperature.

## Typical Performance Curves Unless Otherwise Specified

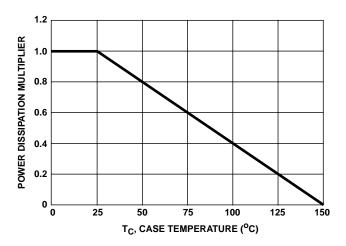


FIGURE 1. NORMALIZED POWER DISSIPATION vs CASE TEMPERATURE

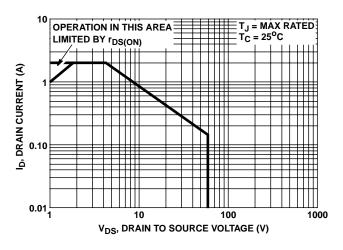


FIGURE 3. FORWARD BIAS SAFE OPERATING AREA

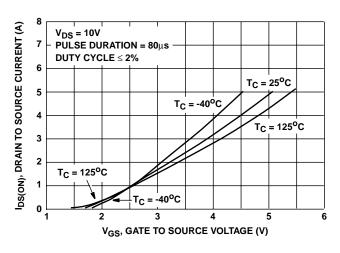


FIGURE 5. TRANSFER CHARACTERISTICS

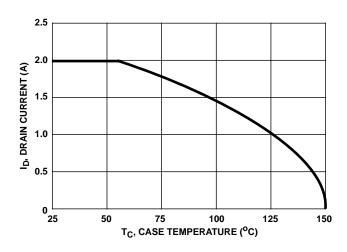


FIGURE 2. MAXIMUM CONTINUOUS DRAIN CURRENT vs CASE TEMPERATURE

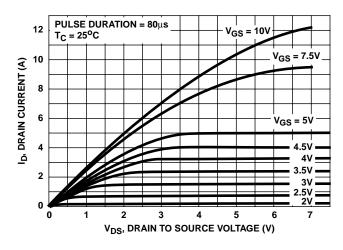


FIGURE 4. SATURATION CHARACTERISTICS

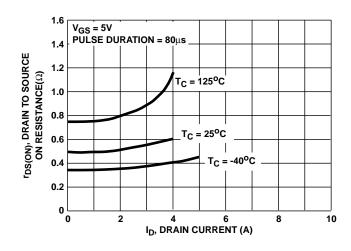


FIGURE 6. DRAIN TO SOURCE ON RESISTANCE vs DRAIN CURRENT

## Typical Performance Curves Unless Otherwise Specified (Continued)

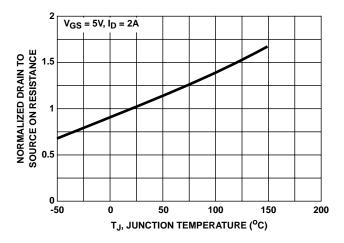


FIGURE 7. NORMALIZED DRAIN TO SOURCE ON RESISTANCE vs JUNCTION TEMPERATURE

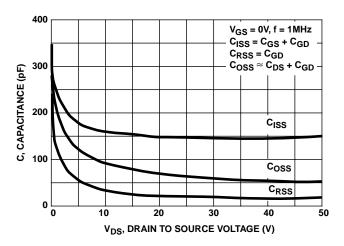


FIGURE 9. CAPACITANCE vs DRAIN TO SOURCE VOLTAGE

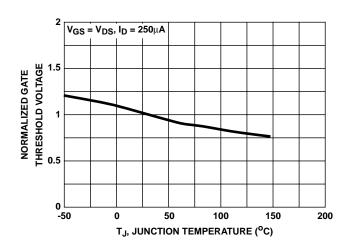
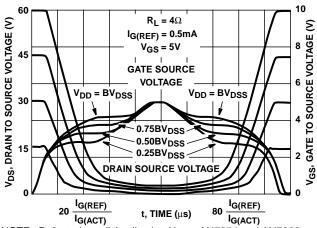


FIGURE 8. NORMALIZED GATE THRESHOLD VOLTAGE vs JUNCTION TEMPERATURE



NOTE: Refer to Intersil Application Notes AN7254 and AN7260.

FIGURE 10. NORMALIZED SWITCHING WAVEFORMS FOR CONSTANT GATE CURRENT

## Test Circuits and Waveforms

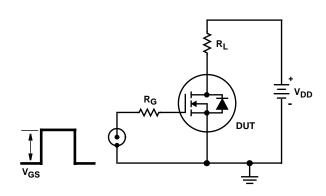


FIGURE 11. SWITCHING TIME TEST CIRCUIT

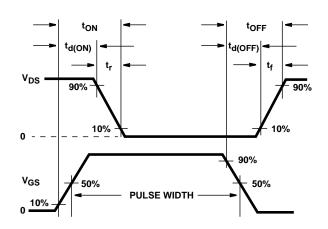


FIGURE 12. RESISTIVE SWITCHING WAVEFORMS

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